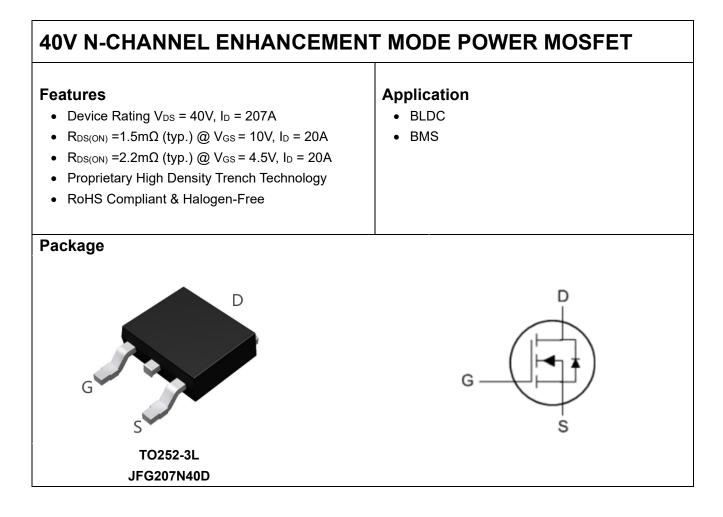


# JFG207N40D

### Description



### Absolute Maximum Ratings Tc=25°C unless otherwise specified

Symbol	Parameter		Max.	Units	
V <sub>DS</sub>	Drain-Source Voltage	ource Voltage		V	
V <sub>GS</sub>	Gate-Source Voltage		± 20	V	
ID	Continuous Drain Current, VGS @ 10V note1	Tc = 25°C	207	А	
		T <sub>C</sub> = 100°C	131	А	
I <sub>DM</sub>	Pulsed Drain Current note2		828	А	
PD	Power Dissipation note4	Tc = 25°C	113	W	
	Power Dissipation	T <sub>A</sub> = 25°C	3.12	W	
Eas	Single Pulsed Avalanche Energy note3		291	mJ	
Rejc	Thermal Resistance, Junction to Case note1		1.1 °C/		
Reja	Junction to Ambient (mounted on 1 inch square PCB)		40	°C/W	
Tj, Tstg	Operating and Storage Temperature Range		-55 to +150	°C	



# JFG207N40D

### Electrical Characteristics Tc=25°C unless otherwise specified

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charac	cteristic					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA	40	-	-	V
IDSS	Drain-Source Leakage Current	V <sub>DS</sub> = 40V, V <sub>GS</sub> = 0V, T <sub>C</sub> = 25°C	-	-	1	μA
		V <sub>DS</sub> = 40V, V <sub>GS</sub> = 0V, T <sub>C</sub> = 55°C	-	-	10	μA
lgss	Gate-Source Leakage Current	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V	-100	-	100	nA
On Charac	cteristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250µA	1.0	-	2.5	V
D	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> =20A	-	1.5	1.8	mΩ
R <sub>DS(on)</sub>	note2	V <sub>GS</sub> = 4.5V, I <sub>D</sub> =20A	-	2.2	2.7	mΩ
<b>g</b> fs	Forward Transconductance	V <sub>DS</sub> = 10V, I <sub>D</sub> =20A		85	-	S
Dynamic C	Characteristics				1	
Rg	Gate Resistance		-	1.4	-	Ω
Ciss	Input Capacitance		-	4980	-	pF
Coss	Output Capacitance	$V_{DS} = 20V, V_{GS} = 0V,$	-	896	-	pF
Crss	Reverse Transfer Capacitance	f = 1MHz	-	861	-	pF
Qg	Total Gate Charge	$V_{DS} = 20V, I_D = 20A,$	-	119	-	nC
Qgs	Gate-Source Charge		-	11.6	-	nC
Q <sub>gd</sub>	Gate-Drain("Miller") Charge	V <sub>GS</sub> = 10V	-	42	-	nC
Switching	Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time		-	30	-	ns
tr	Turn-On Rise Time	V <sub>DD</sub> = 20V, I <sub>D</sub> = 20A,	-	70	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	R <sub>G</sub> = 1Ω, V <sub>GS</sub> = 10V	-	130	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	86	-	ns
Source-Dr	ain Diode Characteristics and Maxin	num Ratings				
ls	Maximum Continuous Diode Forward Current note1,5		-	-	94	А
Ism	Maximum Pulsed Diode Forward Cu	rrent note2,5	-	-	828	А
trr	Reverse Recovery Time	T <sub>J</sub> = 25°C, I <sub>S</sub> = 20A, V <sub>GS</sub> = 0V	-	70	-	ns
Qrr	Reverse Recovery Charge	T <sub>J</sub> = 25°C, I <sub>S</sub> = 20A,	112			nC
		di/dt = 100A/µs				
$V_{\text{SD}} \ ^{\text{note2}}$	Source to Drain Diode Forward Voltage	T <sub>J</sub> = 25°C, I <sub>S</sub> = 20A, V <sub>GS</sub> = 0V	-	0.77	-	V

Note :

1. The data tested by surface mounted on one inch<sup>2</sup> FR-4 board with 2OZ copper.

2.The data tested by pulsed, pulse width  $\leq$  300us, duty cycle  $\leq$  2%.

3.The EAS data shows Max. rating. The test condition is L=0.1mH, I\_{AS}=76.3 A.

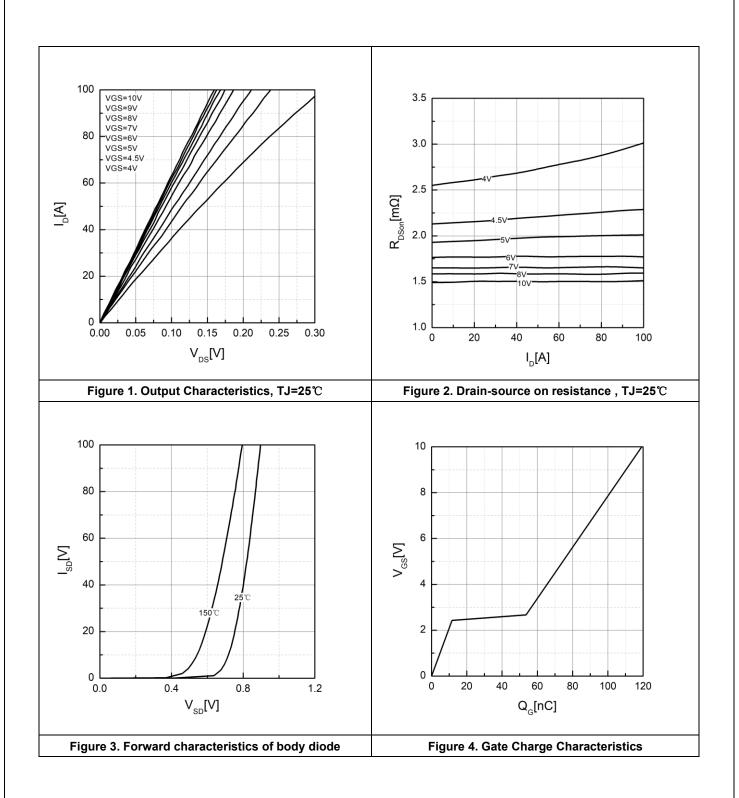
4.The power dissipation is limited by 150  $^\circ\text{C}$  junction temperature.

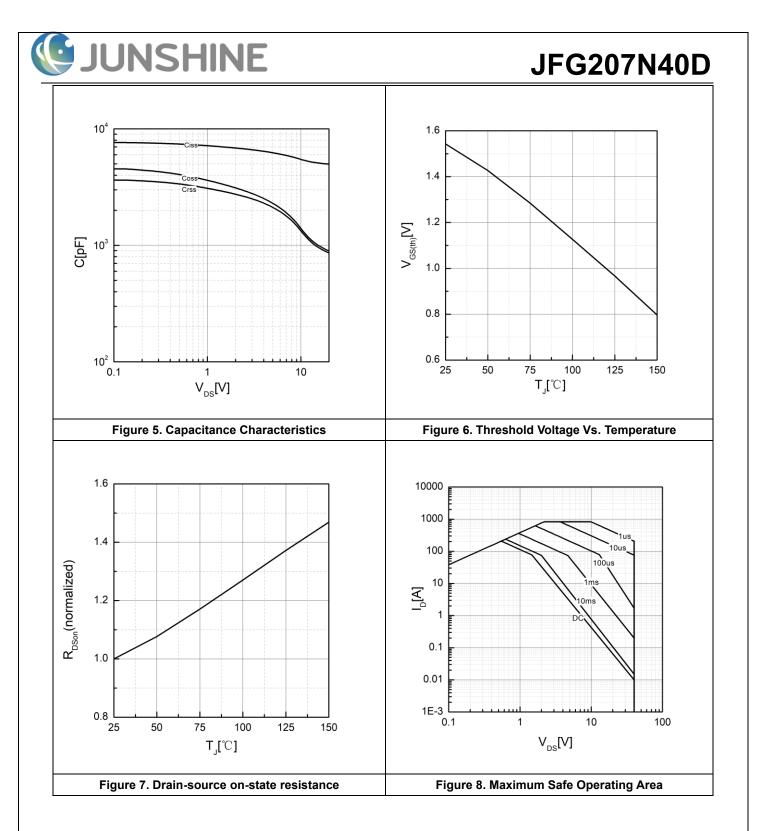
5. The data is theoretically the same as I<sub>D</sub> and I<sub>DM</sub>, in real applications, should be limited by total power dissipation.

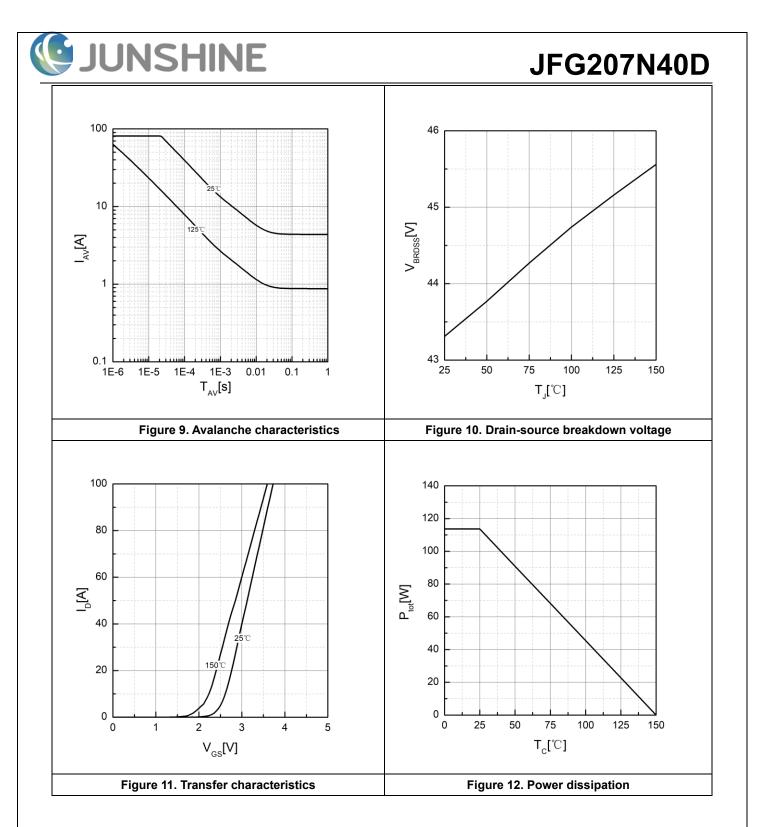


## JFG207N40D

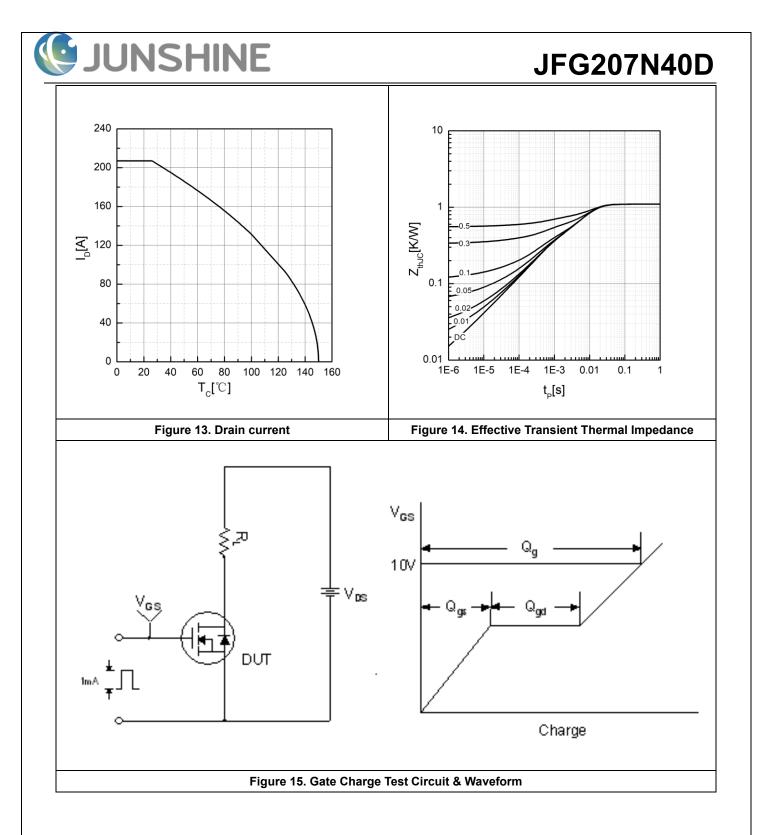
### **Typical Performance Characteristics**

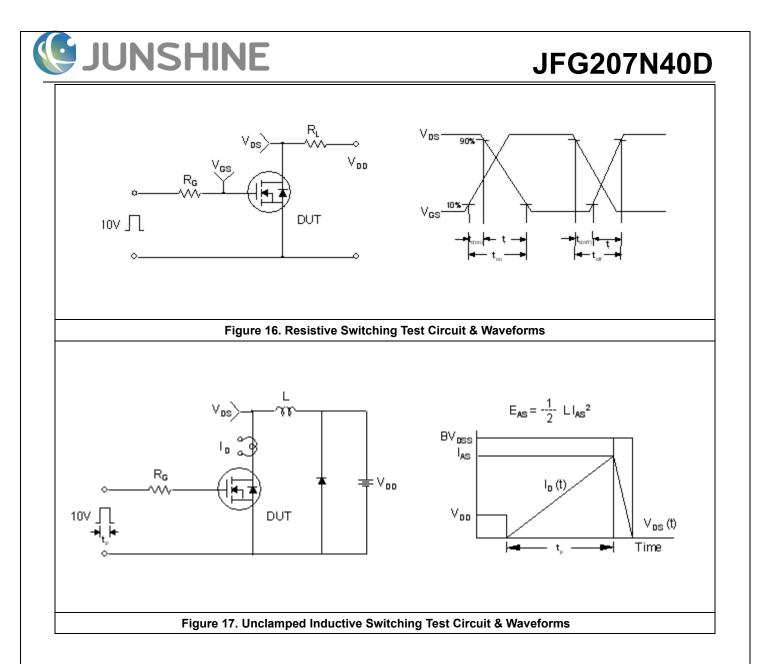


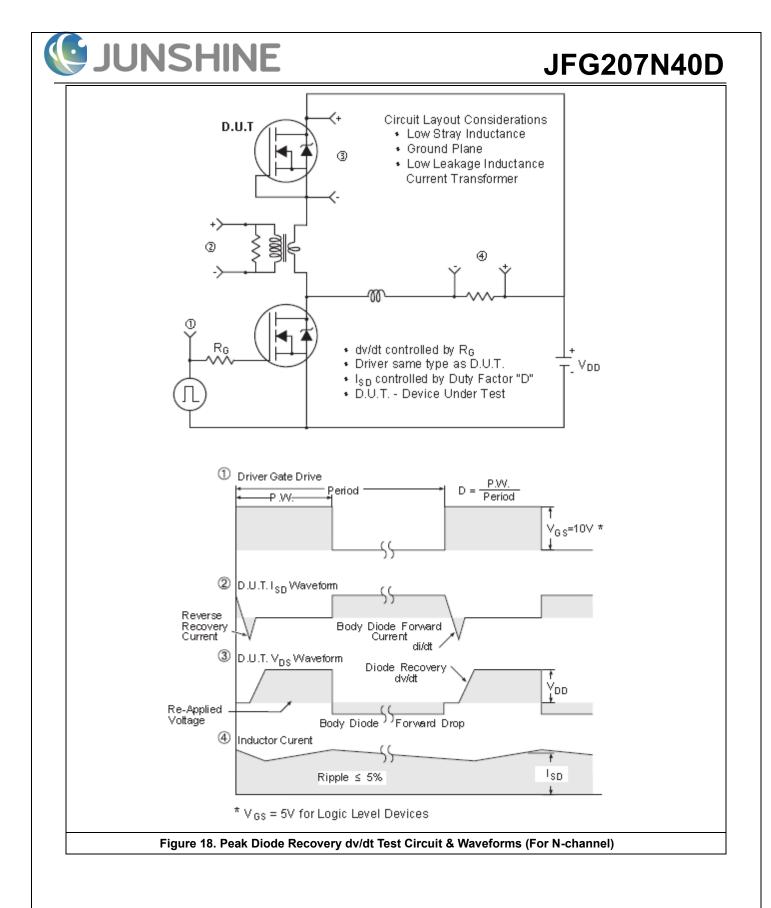




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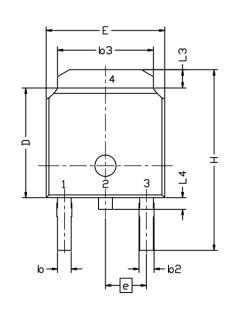


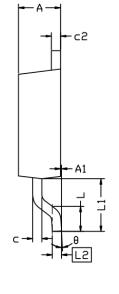


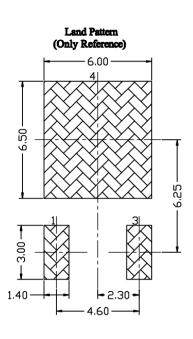
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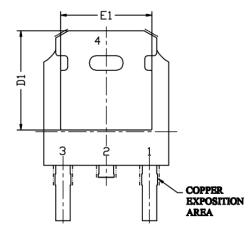
# JFG207N40D

## Package outline









OVNDOL	DIMENSIONAL REQMTS					
SYMBOL	MIN	NDM	MAX			
E	6.40	6.60	6.731			
L	1.40	1.52	1.77			
L1	2.743 REF					
L2	0.508 BSC					
L3	0.89		1.27			
L4	0.64		1.01			
D	6.00	6.10	6.223			
Н	9.40	10.00	10.40			
b	0.64	0.76	0.88			
b2	0.77	0.84	1.14			
b3	5.21	5.34	5.46			
e	2.286 BSC					
A	2.20	2.30	2.38			
A1	0		0.127			
С	0.46	0.50	0.60			
c2	0.46	0.50	0.58			
D1	5.21					
E1	4.40					
θ	0°		10°			

### Figure 19. TO252-3L Package outline

#### Address: Floor 5, D2 Building, No. 200, Linghu Blvd., Wuxi, Jiangsu, China



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